

## PS2705-1

HIGH ISOLATION VOLTAGE AC INPUT RESPONSE TYPE SOP MULTI PHOTOCOUPLER

R08DS0093EJ0300 Rev.3.00 Jan 29, 2013

#### DESCRIPTION

The PS2705-1 is an optically coupled isolator containing a GaAs light emitting diode and an NPN silicon phototransistor.

This package is SOP (Small Outline Package) type and has shield effect to cut off ambient light.

It is designed for high density mounting applications.

#### **FEATURES**

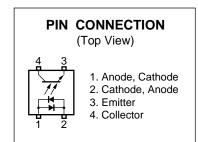
- AC input response
- High isolation voltage (BV = 3 750 Vr.m.s.)
- High current transfer ratio (CTR = 100% TYP.)
- SOP (Small Outline Package) type
- High-speed switching (tr = 3  $\mu$ s TYP., tf = 5  $\mu$ s TYP.)
- Ordering number of taping product: PS2705-1-F3



- Safety standards
  - UL approved: No. E72422
  - BSI approved (BS EN 60065, BS EN 60950)
  - CSA approved: No. CA 101391 (CA5A, CAN/CSA-C22.2 60065, 60950)
  - SEMKO, NEMKO, DEMKO, FIMKO approved (EN 60065, EN 60950)
  - DIN EN 60747-5-5 (VDE 0884-5) approved (Option)

#### **APPLICATIONS**

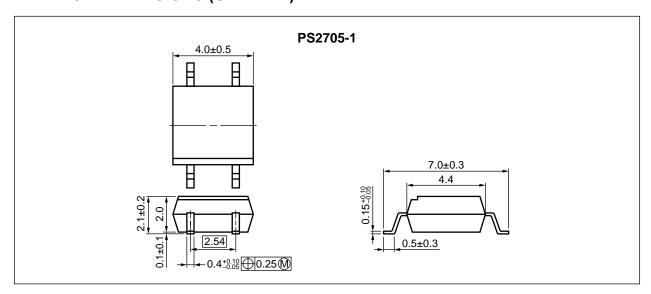
- Hybrid IC
- Telephone/FAX
- FA/OA equipment
- Programmable logic controllers
- Power supply



The mark <R> shows major revised points.

The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

## PACKAGE DIMENSIONS (UNIT: mm)

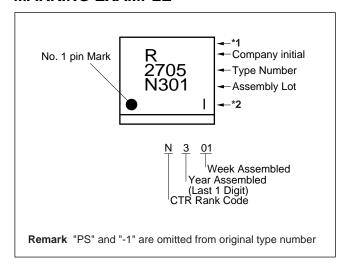


## <R> PHOTOCOUPLER CONSTRUCTION

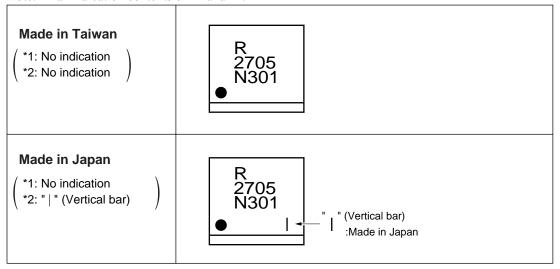
Parameter	Unit (MIN.)
Air Distance	5 mm
Outer Creepage Distance	5 mm
Inner Creepage Distance	2.5 mm
Isolation Distance	0.3 mm

#### <R>

### **MARKING EXAMPLE**



Note: Bar indication contents of \*1 and \*2.



#### <R> ORDERING INFORMATION

Part Number	Order Number	Solder Plating Specification	Packing Style	Safety Standard Approval	Application Part Number*1
PS2705-1-F3	PS2705-1-F3-A	Pb-Free	Embossed Tape 3 500 pcs/reel	Standard products (UL, BSI, CSA, SEMKO, NEMKO, DEMKO, FIMKO approved)	PS2705-1
PS2705-1-V-F3	PS2705-1-V-F3-A		Embossed Tape 3 500 pcs/reel	DIN EN 60747-5-5 (VDE 0884-5) Approved (Option)	

Note: \*1. For the application of the Safety Standard, following part number should be used.

## ABSOLUTE MAXIMUM RATINGS (T<sub>A</sub> = 25°C, unless otherwise specified)

	Parameter	Symbol	Ratings	Unit
Diode	Forward Current (DC)	I <sub>F</sub>	± 50	mA
	Power Dissipation Derating	⊿P <sub>D</sub> /°C	0.8	mW/°C
	Power Dissipation	P <sub>D</sub>	80	mW
	Peak Forward Current*1	I <sub>FP</sub>	± 1	Α
Transistor	Collector to Emitter Voltage	$V_{CEO}$	40	V
	Emitter to Collector Voltage	V <sub>ECO</sub>	6	V
	Collector Current	Ic	80	mA
	Power Dissipation Derating		1.5	mW/°C
Power Dissipation		Pc	150	mW
Isolation Voltage*2		BV	3 750	Vr.m.s.
Operating Ambient Temperature		T <sub>A</sub>	-55 to +100	°C
Storage Temperature		T <sub>stg</sub>	-55 to +150	°C

Note: \*1. PW = 100  $\mu$ s, Duty Cycle = 1%

\*2. AC voltage for 1 minute at  $T_A$  = 25°C, RH = 60% between input and output. Pins 1-2 shorted together, 3-4 shorted together.

## ELECTRICAL CHARACTERISTICS ( $T_A = 25$ °C)

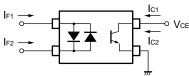
Parameter		Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Diode	Forward Voltage	V <sub>F</sub>	$I_F = \pm 5 \text{ mA}$		1.1	1.4	V
	Terminal Capacitance	Ct	V = 0 V, f = 1 MHz		60		pF
Transistor	Collector to Emitter Dark Current	I <sub>CEO</sub>	I <sub>F</sub> = 0 mA, V <sub>CE</sub> = 40 V			100	nA
Coupled	Current Transfer Ratio $\left(I_{\text{C}}/I_{\text{F}}\right)^{*1}$	CTR	$I_F = \pm 5 \text{ mA}, V_{CE} = 5 \text{ V}$	50	100	300	%
	CTR Ratio*2	CTR <sub>1</sub> / CTR <sub>2</sub>	$I_F = \pm 5$ mA, $V_{CE} = 5$ V	0.3	1.0	3.0	
	Collector Saturation Voltage	V <sub>CE (sat)</sub>	$I_F = \pm 10 \text{ mA}, I_C = 2 \text{ mA}$			0.3	V
	Isolation Resistance	R <sub>I-O</sub>	$V_{I-O} = 1 \text{ kV}_{DC}$	10 <sup>11</sup>			Ω
	Isolation Capacitance	C <sub>I-O</sub>	V = 0 V, f = 1 MHz		0.4		pF
	Rise Time*3	t <sub>r</sub>	$V_{CC} = 5 \text{ V}, I_{C} = 2 \text{ mA}, R_{L} = 100 \Omega$		3		μs
	Fall Time*3	t <sub>f</sub>			5		
	Turn-on Time*3	t <sub>on</sub>			5		
	Turn-off Time*3	t <sub>off</sub>			4		

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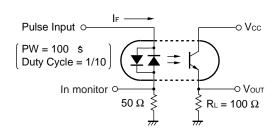
Note: \*1. CTR rank

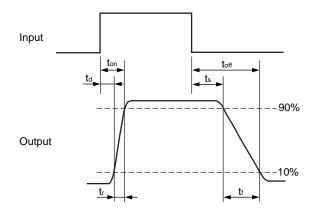
M: 50 to 150 (%) L: 100 to 300 (%) N: 50 to 300 (%)

\*2.  $CTR_1 = I_{C1}/I_{F1}$ ,  $CTR_2 = I_{C2}/I_{F2}$ 

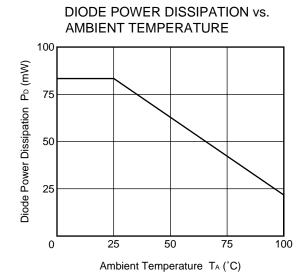


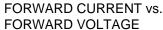
#### \*3. Test Circuit for Switching Time

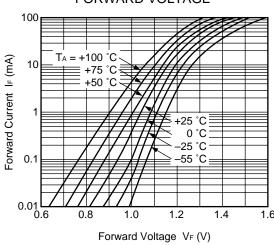




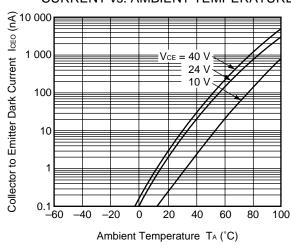
## TYPICAL CHARACTERISTICS (T<sub>A</sub> = 25°C, unless otherwise specified)





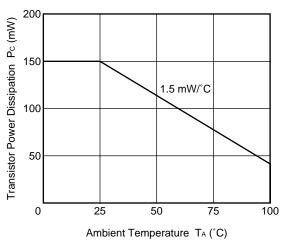


#### COLLECTOR TO EMITTER DARK **CURRENT vs. AMBIENT TEMPERATURE**

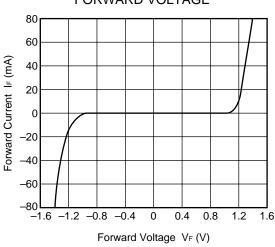


**Remark** The graphs indicate nominal characteristics.

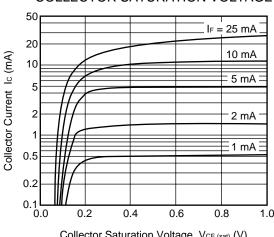
#### TRANSISTOR POWER DISSIPATION vs. AMBIENT TEMPERATURE



#### FORWARD CURRENT vs. FORWARD VOLTAGE

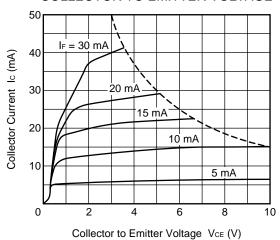


#### COLLECTOR CURRENT vs. **COLLECTOR SATURATION VOLTAGE**

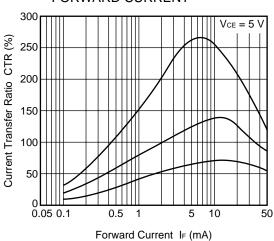


Collector Saturation Voltage VcE (sat) (V)

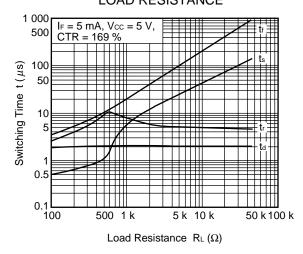
# COLLECTOR CURRENT vs. COLLECTOR TO EMITTER VOLTAGE



# CURRENT TRANSFER RATIO vs. FORWARD CURRENT

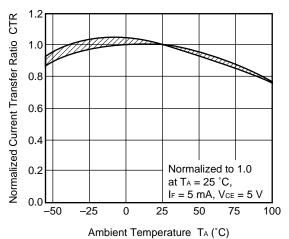


#### SWITCHING TIME vs. LOAD RESISTANCE

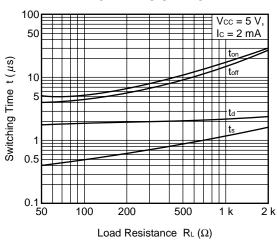


#### Remark The graphs indicate nominal characteristics.

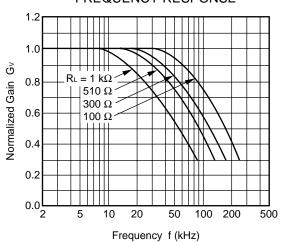
# NORMALIZED CURRENT TRANSFER RATIO vs. AMBIENT TEMPERATURE



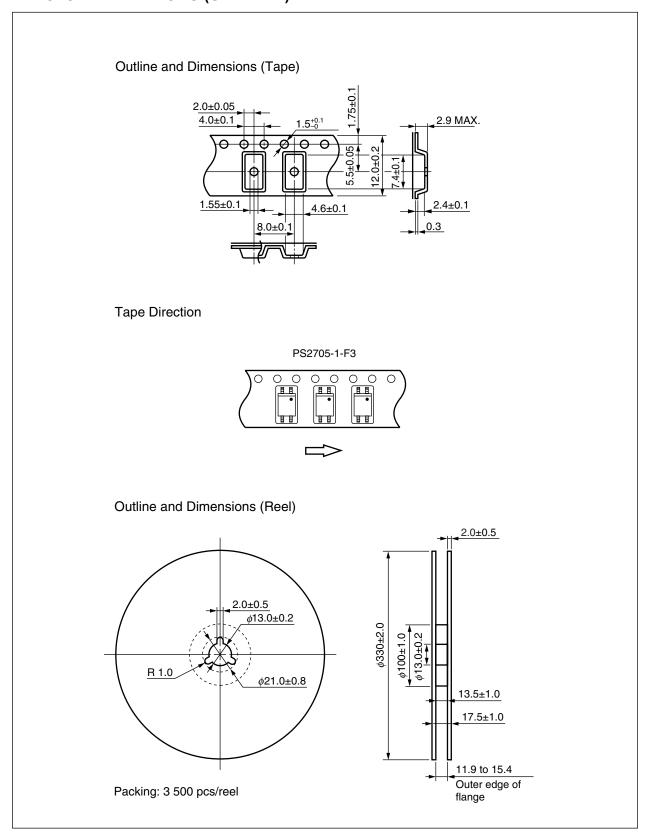
# SWITCHING TIME vs. LOAD RESISTANCE



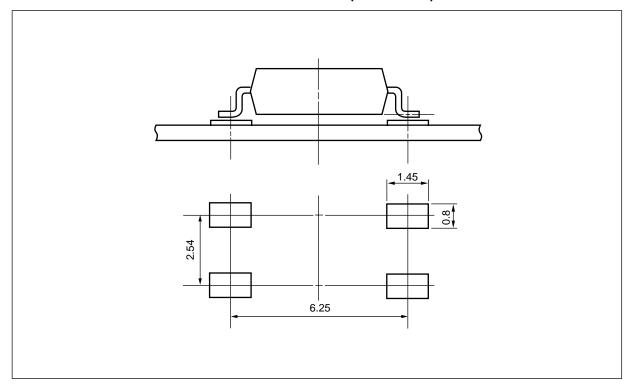
#### FREQUENCY RESPONSE



## <R> TAPING SPECIFICATIONS (UNIT: mm)



## <R> RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)



**Remark** All dimensions in this figure must be evaluated before use.

#### **NOTES ON HANDLING**

- 1. Recommended soldering conditions
  - (1) Infrared reflow soldering
    - Peak reflow temperature 260°C or below (package surface temperature)
    - Time of peak reflow temperature
    - Time of temperature higher than 220°C 60 seconds or less
    - Time to preheat temperature from 120 to 180°C
    - Number of reflows
    - Flux

10 seconds or less

120±30 s

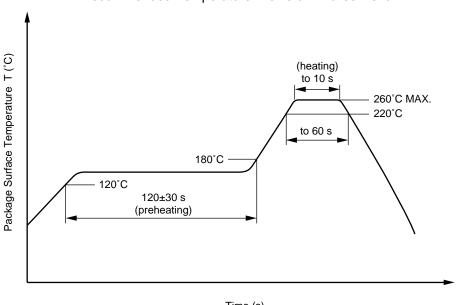
Three

Rosin flux containing small amount of chlorine (The flux

with a maximum chlorine content of 0.2 Wt% is

recommended.)

#### Recommended Temperature Profile of Infrared Reflow



Time (s)

#### (2) Wave soldering

Temperature 260°C or below (molten solder temperature)

Time 10 seconds or less

Preheating conditions 120°C or below (package surface temperature)

Number of times One (Allowed to be dipped in solder including plastic mold portion.)

Rosin flux containing small amount of chlorine (The flux with a maximum chlorine Flux

content of 0.2 Wt% is recommended.)

#### (3) Soldering by Soldering Iron

Peak Temperature (lead part temperature) 350°C or below

Time (each pins) 3 seconds or less

Flux Rosin flux containing small amount of chlorine (The flux with a

maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

#### (4) Cautions

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Avoid removing the residual flux with freon-based and chlorine-based cleaning solvent. Fluxes

2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collectoremitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

3. Measurement conditions of current transfer ratios (CTR), which differ according to photocoupler Check the setting values before use, since the forward current conditions at CTR measurement differ according to product.

When using products other than at the specified forward current, the characteristics curves may differ from the standard curves due to CTR value variations or the like. This tendency may sometimes be obvious, especially below  $I_F = 1 \text{ mA}$ .

Therefore, check the characteristics under the actual operating conditions and thoroughly take variations or the like into consideration before use.

#### **USAGE CAUTIONS**

- 1. Protect against static electricity when handling.
- 2. Avoid storage at a high temperature and high humidity.

## <R> SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

Parameter	Symbol	Spec.	Unit
Climatic test class (IEC 60068-1/DIN EN 60068-1)		55/100/21	
Dielectric strength			
maximum operating isolation voltage	U <sub>IORM</sub>	707	$V_{peak}$
Test voltage (partial discharge test, procedure a for type test and	$U_pr$	1 131	$V_{peak}$
random test)			
Upr = $1.6 \times U_{IORM}$ , $P_d < 5 pC$			
Test voltage (partial discharge test, procedure b for all devices)	Upr	1 325	$V_{peak}$
$U_{pr}$ = 1.875 × $U_{IORM}$ , $P_d$ < 5 pC			
Highest permissible overvoltage	$U_{TR}$	6 000	$V_{peak}$
Degree of pollution (DIN EN 60664-1 VDE0110 Part 1)		2	
Comparative tracking index (IEC 60112/DIN EN 60112 (VDE 0303	CTI	175	
Part 11))			
Material group (DIN EN 60664-1 VDE0110 Part 1)		III a	
Storage temperature range	T <sub>stg</sub>	-55 to +150	°C
Operating temperature range	T <sub>A</sub>	-55 to +100	°C
Isolation resistance, minimum value			
$V_{IO} = 500 \text{ V dc at } T_A = 25^{\circ}\text{C}$	Ris MIN.	10 <sup>12</sup>	Ω
V <sub>IO</sub> = 500 V dc at T <sub>A</sub> MAX. at least 100°C	Ris MIN.	10 <sup>11</sup>	Ω
Safety maximum ratings (maximum permissible in case of fault, see			
thermal derating curve)			
Package temperature	Tsi	150	°C
Current (input current I <sub>F</sub> , Psi = 0)	Isi	300	mA
Power (output or total power dissipation)	Psi	500	mW
Isolation resistance		0	
$V_{IO}$ = 500 V dc at $T_A$ = Tsi	Ris MIN.	10 <sup>9</sup>	Ω

#### Caution

GaAs Products

This product uses gallium arsenide (GaAs).

GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.

- Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.
  - Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.
- 2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.
- Do not burn, destroy, cut, crush, or chemically dissolve the product.
- Do not lick the product or in any way allow it to enter the mouth.

## PS2705-1 Data Sheet

		Description			
Rev.	Date	Page	Summary		
1.00	Mar 31, 2003	_	This data sheet was released as PN10243EJ01V0DS		
3.00 Jan 29, 2013		Throughout	Renesas format is applied to this data sheet.		
		p.1	The safety standards are revised.		
		p.2	PHOTOCOUPLER CONSTRUCTION is added.		
		p.3	The explanation in MARKING EXAMPLE is revised.		
		p.4	ORDERING INFORMATION is modified with the revision of the safety standards.		
		p.5	Turn-on Time (t <sub>on</sub> ) and Turn-off Time(t <sub>off</sub> ) are added to the table in ELECTRICAL CHARACTERISTICS.		
			Time chart for switching time is added.		
		p.7	The graph of LONG TERM CTR DEGRADATION is deleted from those in TYPICAL CHARACTERISTICS.		
		p.8	PS2705-1F4 is deleted form Tape Direction image in TAPING SPECIFICATIONS.		
		p.9	RECOMMENDED MOUNT PAD DIMENSIONS is added.		
		p.10	The note about temperature condition of the recommended soldering conditions is deleted.		
		p.12	SPECIFICATION OF VDE MARKS LICENSE DOCUMENT is revised.		

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